2N2905A

Small Signal Switching Transistor

PNP Silicon

Features

- MIL-PRF-19500/290 Qualified
- Available as JAN, JANTX, and JANTXV

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-60	Vdc
Collector - Base Voltage	V _{CBO}	-60	Vdc
Emitter - Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current - Continuous	I _C	-600	mAdc
Total Device Dissipation @ T _A = 25°C	P _T	800	mW
Total Device Dissipation @ T _C = 25°C	P _T	3.0	W
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200	°C

THERMAL CHARACTERISTICS

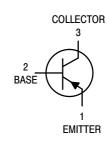
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	195	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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TO-39 CASE 205AB STYLE 1

ORDERING INFORMATION

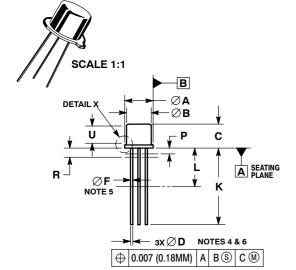
Device	Package	Shipping
JAN2N2905A		
JANTX2N2905A	TO-39	Bulk
JANTXV2N2905A		

2N2905A

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Breakdown Voltage (Note 1) (I _C = –10 mAdc)	V _(BR) CEO	-60	_	Vdc
Collector–Emitter Cutoff Current (V _{CE} = -60 Vdc)	I _{CES}	-	-1.0	μAdc
Collector-Base Cutoff Current (V _{CB} = -50 Vdc) (V _{CB} = -60 Vdc)	Ісво	- -	-10 -10	nAdc μAdc
Emitter-Base Cutoff Current (V _{EB} = -5.0 Vdc) (V _{EB} = -3.5 Vdc)	I _{EBO}	- -	-10 -50	μAdc nAdc
ON CHARACTERISTICS (Note 1)				
	h _{FE}	75 100 100 100 50	- 450 - 300 -	-
Collector – Emitter Saturation Voltage ($I_C = -150$ mAdc, $I_B = -15$ mAdc) ($I_C = -500$ mAdc, $I_B = -50$ mAdc)	V _{CE(sat)}	- -	-0.4 -1.6	Vdc
Base – Emitter Saturation Voltage (I _C = -150 mAdc, I _B = -15 mAdc) (I _C = -500 mAdc, I _B = -50 mAdc)	V _{BE(sat)}	- -	-1.3 -2.6	Vdc
SMALL-SIGNAL CHARACTERISTICS		•		
Magnitude of Small Signal Current Gain (I _C = -50 mAdc, V _{CE} = -20 Vdc, f = 100 MHz)	h _{fe}	2.0	_	_
Small Signal Current Gain (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1 kHz)	h _{fe}	100	-	-
Output Capacitance ($V_{CB} = -10 \text{ Vdc}$, $I_E = 0$, 100 kHz $\leq f \leq 1.0 \text{ MHz}$)	C _{obo}	-	8.0	pF
Input Capacitance ($V_{EB} = -2.0 \text{ Vdc}$, $I_C = 0$, 100 kHz \leq f \leq 1.0 MHz)	C _{ibo}	-	30	pF
SWITCHING CHARACTERISTICS				
Turn-On Time (Reference Figure in MIL-PRF-19500/290)	t _{on}	_	45	ns
Turn-Off Time (Reference Figure in MIL-PRF-19500/290)	t _{off}	_	300	ns

Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.



TO-39 3-Lead CASE 205AB **ISSUE A**

DATE 25 JUN 2012

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: INCHES.

 3. DIMENSION J MEASURED FROM DIAMETER A TO EDGE.

 4. LEAD TRUE POSITION TO BE DETERMINED AT THE GUAGE PLANE DEFINED BY DIMENSION R.

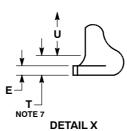
 5. DIMENSION F APPLIES BETWEEN DIMENSION P AND L.

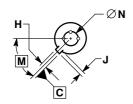
 6. DIMENSION D APPLIES BETWEEN DIMENSION LAND K.

 7. BODY CONTOUR OPTIONAL WITHIN ZONE DEFINED BY DIMENSIONS A, B, AND T.

 8. DIMENSION B SHALL NOT VARY MORE THAN 0.010 IN ZONE P.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.89	9.40	0.350	0.370
В	8.00	8.51	0.315	0.335
С	6.10	6.60	0.240	0.260
D	0.41	0.48	0.016	0.019
E	0.23	3.18	0.009	0.125
F	0.41	0.48	0.016	0.019
Н	0.71	0.86	0.028	0.034
J	0.73	1.02	0.029	0.040
K	12.70	14.73	0.500 0.580	
L	6.35		0.250	
M	45°BSC		45 °BSC	
N	5.08 BSC		0.200 BSC	
P		1.27	0.050	
R	1.37 BSC		0.054 BSC	
T		0.76		0.030
U	2.54		0.100	







DETAIL

STYLE 1: PIN 1. EMITTER 2. BASE 3. COLLECTOR

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PAGE 2 OF 2

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0	RELEASED FOR PRODUCTION. REQ. BY B. JENSEN.	18 MAR 2010			
А	MADE ISOMETRIC IMAGE LARGER TO REFLECT ACTUAL SIZE. REQ. BY J. FULTON.	25 JUN 2012			
-					

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